

# STP16NF06 STP16NF06FP

N-channel 60V - 0.08Ω - 16A - TO-220/TO-220FP STripFET™ II Power MOSFET

#### **General features**

| Туре        | V <sub>DSS</sub> | R <sub>DS(on)</sub> | I <sub>D</sub> |
|-------------|------------------|---------------------|----------------|
| STP16NF06   | 60V              | <0.1Ω               | 16A            |
| STP16NF06FP | 60V              | <0.1Ω               | 11A            |

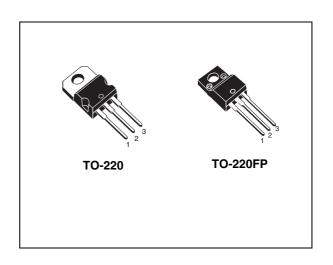
- Exceptional dv/dt capability
- Low gate charge at 100°C
- Application oriented characterization

### **Description**

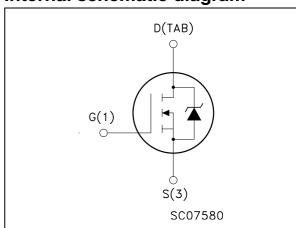
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size<sup>TM</sup>" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

### **Applications**

■ Switching application



### Internal schematic diagram



#### **Order codes**

| Part number | Marking | Package  | Packaging |
|-------------|---------|----------|-----------|
| STP16NF06   | P16NF06 | TO-220   | Tube      |
| STP16NF06FP | P16NF06 | TO-220FP | Tube      |

## **Contents**

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# 1 Electrical ratings

Table 1. Absolute maximum ratings

| Symbol                         | Parameter  | Va         | lue                | Unit |
|--------------------------------|--|------------|--------------------|------|
|                                |  | TO-220     | TO-220FP           |      |
| V <sub>DS</sub>                | Drain-source voltage (V <sub>GS</sub> = 0)           | 6          | 0                  | V    |
| V <sub>GS</sub>                | Gate- source voltage                                 | ±          | 20                 | V    |
| I <sub>D</sub>                 | Drain current (continuous) at T <sub>C</sub> = 25°C  | 16         | 11 <sup>(1)</sup>  | Α    |
| I <sub>D</sub>                 | Drain current (continuous) at T <sub>C</sub> = 100°C | 11         | 7.5 <sup>(1)</sup> | Α    |
| I <sub>DM</sub> <sup>(2)</sup> | Drain current (pulsed)                               | 64         | 44 <sup>(1)</sup>  | Α    |
| P <sub>tot</sub>               | Total dissipation at T <sub>C</sub> = 25°C           | 45         | 25                 | W    |
|                                | Derating factor                                      | 0.3        | 0.17               | W/°C |
| dv/dt (3)                      | Peak diode recovery voltage slope                    | 2          | V/ns               |      |
| E <sub>AS</sub> (4)            | Single pulse avalanche energy                        | 130        |                    | mJ   |
| I <sub>AR</sub>                | Avalanche current, repetitive or not-<br>repetitive  | 6          | Α                  |      |
| V <sub>ISO</sub>               | Insulation withstand voltage (DC)                    |            | 2500               | V    |
| T <sub>stg</sub>               | Storage temperature                                  | -55 to 175 |                    | °C   |
| Tj                             | Max. operating junction temperature                  | J 175      | C                  |      |

- 1. Current limited by package's thermal resistance
- 2. Pulse width limited by safe operating area.
- 3.  $I_{SD} \leq 16A$ , di/dt  $\leq 200A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $Tj \leq T_{JMAX}$
- 4. Starting  $T_i = 25$  °C,  $I_D = 8A$ ,  $V_{DD} = 30V$

Table 2. Thermal data

|           | TO-220 TO-220FP                                |    |      |  |  |  |
|-----------|--|----|------|--|--|--|
| Rthj-case | Thermal resistance junction-case max 3.33 6    |    |      |  |  |  |
| Rthj-amb  | Thermal resistance junction-ambient max        | 62 | °C/W |  |  |  |
| TJ        | Maximum lead temperature for soldering purpose | 30 | °C   |  |  |  |

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## 2 Electrical characteristics

(T<sub>CASE</sub>=25°C unless otherwise specified)

Table 3. On/off states

| Symbol               | Parameter  | Test conditions  | Min. | Тур. | Max.    | Unit                     |
|----------------------|--|--|------|------|---------|--------------------------|
| V <sub>(BR)DSS</sub> | Drain-source<br>breakdown voltage                        | $I_D = 250 \mu A, V_{GS} = 0$  | 60   |      |         | V                        |
| I <sub>DSS</sub>     | Zero gate voltage<br>drain current (V <sub>GS</sub> = 0) | $V_{DS}$ = max ratings<br>$V_{DS}$ = max ratings,<br>$T_{C}$ = 125°C |      |      | 1<br>10 | μ <b>Α</b><br>μ <b>Α</b> |
| I <sub>GSS</sub>     | Gate-body leakage current (V <sub>DS</sub> = 0)          | V <sub>GS</sub> = ± 20V  |      |      | ±100    | nA                       |
| V <sub>GS(th)</sub>  | Gate threshold voltage                                   | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$                                 | 2    |      | 4       | V                        |
| R <sub>DS(on)</sub>  | Static drain-source on resistance                        | $V_{GS} = 10V, I_D = 8A$   |      | 0.08 | 0.1     | Ω                        |

Table 4. Dynamic

| Symbol   | Parameter   | Test conditions  | Min. | Тур.               | Max. | Unit           |
|--|---|--|------|--------------------|------|----------------|
| 9 <sub>fs</sub> <sup>(1)</sup>                                       | Forward transconductance  | V <sub>DS</sub> = 15V, I <sub>D</sub> = 8A   |      | 6.5                |      | S              |
| C <sub>iss</sub><br>C <sub>oss</sub><br>C <sub>rss</sub>             | Input capacitance Output capacitance Reverse transfer capacitance   | $V_{DS} = 25V, f = 1MHz,$<br>$V_{GS} = 0$  |      | 315<br>70<br>30    |      | pF<br>pF<br>pF |
| t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> | Turn-on delay time<br>Rise time<br>Turn-off delay time<br>Fall time | $V_{DD}$ = 30V, $I_{D}$ = 8A<br>$R_{G}$ = 4.7 $\Omega$ $V_{GS}$ = 10V<br>(see <i>Figure 15</i> ) |      | 7<br>18<br>17<br>6 |      | ns<br>ns<br>ns |
| Q <sub>g</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub>                 | Total gate charge<br>Gate-source charge<br>Gate-drain charge        | $V_{DD} = 48V$ , $I_D = 16A$ ,<br>$V_{GS} = 10V$<br>(see <i>Figure 16</i> )                      |      | 10<br>3.5<br>3.5   | 13   | nC<br>nC<br>nC |

<sup>1.</sup> Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5%.

Table 5. Source drain diode

| Symbol   | Parameter  | Test conditions  | Min. | Тур.            | Max.     | Unit          |
|--|--|--|------|-----------------|----------|---------------|
| I <sub>SD</sub>  | Source-drain current<br>Source-drain current<br>(pulsed)               |  |      |                 | 16<br>64 | A<br>A        |
| V <sub>SD</sub> <sup>(2)</sup>                         | Forward on voltage   | I <sub>SD</sub> = 16A, V <sub>GS</sub> = 0   |      |                 | 1.3      | V             |
| t <sub>rr</sub><br>Q <sub>rr</sub><br>I <sub>RRM</sub> | Reverse recovery time Reverse recovery charge Reverse recovery current | $I_{SD} = 15A$ ,<br>$di/dt = 100A/\mu s$ ,<br>$V_{DD} = 30V$ , $T_j = 150^{\circ}C$<br>(see <i>Figure 17</i> ) |      | 50<br>88<br>3.5 |          | ns<br>nC<br>A |

- 1. Pulse width limited by safe operating area.
- 2. Pulsed: Pulse duration = 300  $\mu$ s, duty cycle 1.5%

### 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area for TO-220

Figure 2. Thermal impedance for TO-220

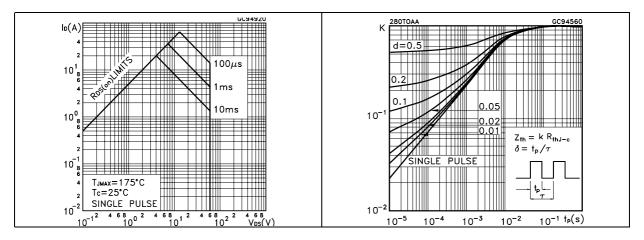


Figure 3. Safe operating area for TO-220FP

Figure 4. Thermal impedance for TO-220FP

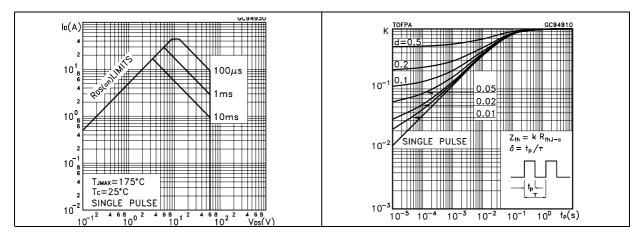
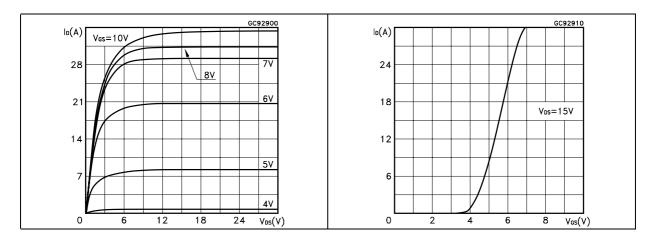


Figure 5. Output characteristics

Figure 6. Transfer characteristics



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Figure 7. Transconductance

Figure 8. Static drain-source on resistance

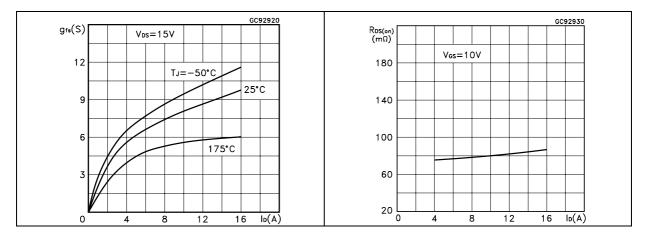


Figure 9. Gate charge vs. gate-source voltage Figure 10. Capacitance variations

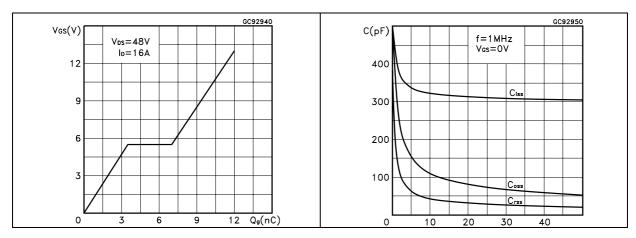


Figure 11. Normalized gate threshold voltage Figure 12. Normalized on resistance vs. vs. temperature temperature

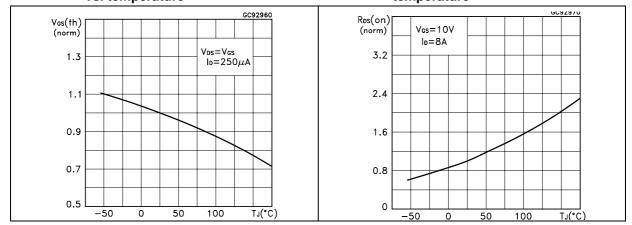
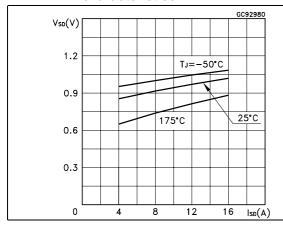
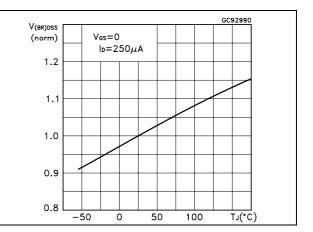


Figure 13. Source-drain diode forward characteristics

Figure 14. Normalized  $\mathbf{B}_{\text{VDSS}}$  vs. temperature





### 3 Test circuit

Figure 15. Switching times test circuit for resistive load

Figure 16. Gate charge test circuit

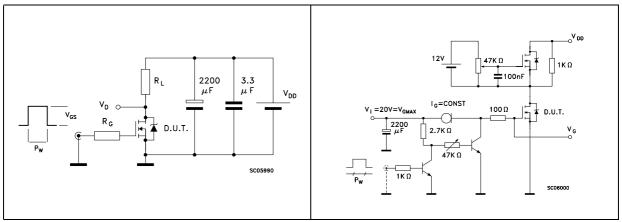


Figure 17. Test circuit for inductive load switching and diode recovery times

Figure 18. Unclamped Inductive load test circuit

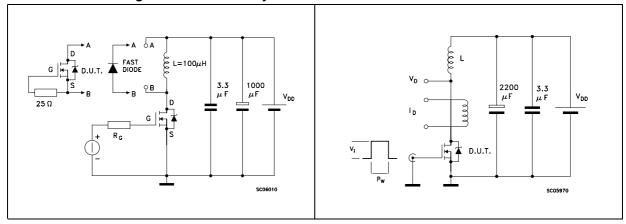
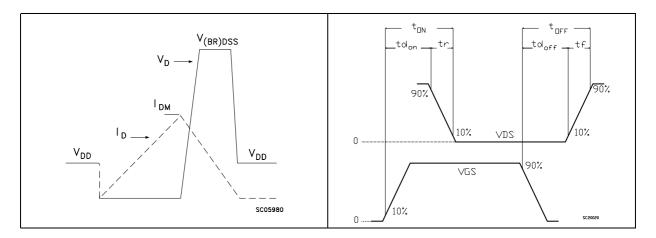


Figure 19. Unclamped inductive waveform

Figure 20. Switching time waveform



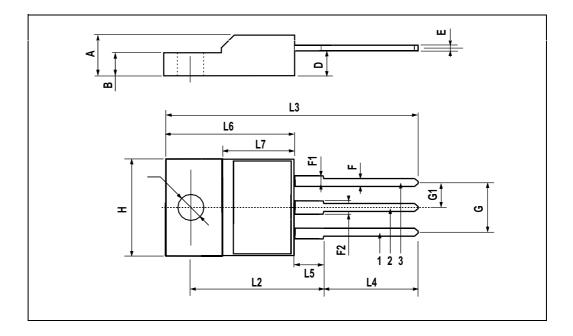
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## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

#### **TO-220FP MECHANICAL DATA**

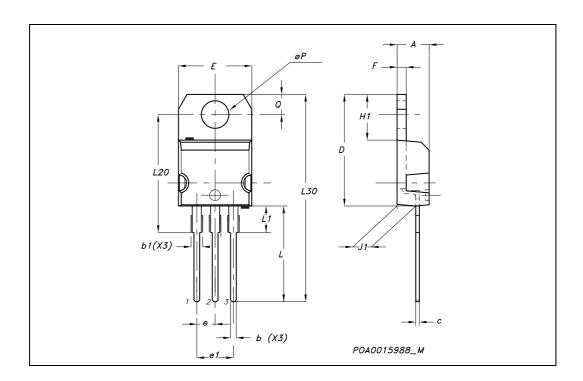
| DIM  |      | mm. |      |       | inch  |       |
|------|------|-----|------|-------|-------|-------|
| DIM. | MIN. | TYP | MAX. | MIN.  | TYP.  | MAX.  |
| Α    | 4.4  |     | 4.6  | 0.173 |       | 0.181 |
| В    | 2.5  |     | 2.7  | 0.098 |       | 0.106 |
| D    | 2.5  |     | 2.75 | 0.098 |       | 0.108 |
| E    | 0.45 |     | 0.7  | 0.017 |       | 0.027 |
| F    | 0.75 |     | 1    | 0.030 |       | 0.039 |
| F1   | 1.15 |     | 1.7  | 0.045 |       | 0.067 |
| F2   | 1.15 |     | 1.7  | 0.045 |       | 0.067 |
| G    | 4.95 |     | 5.2  | 0.195 |       | 0.204 |
| G1   | 2.4  |     | 2.7  | 0.094 |       | 0.106 |
| Н    | 10   |     | 10.4 | 0.393 |       | 0.409 |
| L2   |      | 16  |      |       | 0.630 |       |
| L3   | 28.6 |     | 30.6 | 1.126 |       | 1.204 |
| L4   | 9.8  |     | 10.6 | .0385 |       | 0.417 |
| L5   | 2.9  |     | 3.6  | 0.114 |       | 0.141 |
| L6   | 15.9 |     | 16.4 | 0.626 |       | 0.645 |
| L7   | 9    |     | 9.3  | 0.354 |       | 0.366 |
| Ø    | 3    |     | 3.2  | 0.118 |       | 0.126 |



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#### **TO-220 MECHANICAL DATA**

| DIM. |       | mm. inch |       |       |       |       |
|------|-------|----------|-------|-------|-------|-------|
| DIM. | MIN.  | TYP      | MAX.  | MIN.  | TYP.  | MAX.  |
| Α    | 4.40  |          | 4.60  | 0.173 |       | 0.181 |
| b    | 0.61  |          | 0.88  | 0.024 |       | 0.034 |
| b1   | 1.15  |          | 1.70  | 0.045 |       | 0.066 |
| С    | 0.49  |          | 0.70  | 0.019 |       | 0.027 |
| D    | 15.25 |          | 15.75 | 0.60  |       | 0.620 |
| E    | 10    |          | 10.40 | 0.393 |       | 0.409 |
| е    | 2.40  |          | 2.70  | 0.094 |       | 0.106 |
| e1   | 4.95  |          | 5.15  | 0.194 |       | 0.202 |
| F    | 1.23  |          | 1.32  | 0.048 |       | 0.052 |
| H1   | 6.20  |          | 6.60  | 0.244 |       | 0.256 |
| J1   | 2.40  |          | 2.72  | 0.094 |       | 0.107 |
| L    | 13    |          | 14    | 0.511 |       | 0.551 |
| L1   | 3.50  |          | 3.93  | 0.137 |       | 0.154 |
| L20  |       | 16.40    |       |       | 0.645 |       |
| L30  |       | 28.90    |       |       | 1.137 |       |
| øΡ   | 3.75  |          | 3.85  | 0.147 |       | 0.151 |
| Q    | 2.65  |          | 2.95  | 0.104 |       | 0.116 |



# 5 Revision history

Table 6. Revision history

| Date        | Revision | Changes                         |
|-------------|----------|---------------------------------|
| 09-Sep-2004 | 4        | Preliminary version             |
| 28-Jun-2005 | 5        | Complete version                |
| 21-Jul-2005 | 6        | ECOPACK label inserted          |
| 09-Aug-2006 | 7        | New template, no content change |
| 20-Feb-2007 | 8        | Typo mistake on page 1          |

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